



Material Content Data Sheet



Sales Product Name		SPA06N80C3		Issued		25. January 2018		
MA#		MA001730858						
Package		PG-TO220-3-317		Weight*		2124.02 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.945	0.23	0.23	2328	2328
leadframe	inorganic material	phosphorus	7723-14-0	0.361	0.02		170	
	non noble metal	iron	7439-89-6	1.202	0.06		566	
	non noble metal	copper	7440-50-8	1200.685	56.53	56.61	565290	566026
	non noble metal	aluminium	7429-90-5	0.811	0.04	0.04	382	382
wire	non noble metal	aluminium	7429-90-5	0.811	0.04	0.04	382	382
encapsulation	organic material	carbon black	1333-86-4	9.000	0.42		4237	
	plastics	epoxy resin	-	145.500	6.85		68502	
	inorganic material	silicondioxide	60676-86-0	750.839	35.35	42.62	353499	426238
leadfinish	non noble metal	tin	7440-31-5	7.889	0.37	0.37	3714	3714
solder	non noble metal	antimony	7440-36-0	0.279	0.01		131	
	noble metal	silver	7440-22-4	0.697	0.03		328	
	non noble metal	tin	7440-31-5	1.811	0.09	0.13	853	1312
*deviation	< 10%			Sum in total:		100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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